

LNPTM STAT-LOYTM COMPOUND D3000EC

DESCRIPTION

LNP STAT-LOY D3000EC compound is a Polycarbonate (PC) resin based electrically conductive material with colorability, low surface resistivity, high flow and high cleanliness. Added features of this grade include LNP Clean Compounding Technology. This material is targeted for jigs, fixtures, and boxes for semi-conductor/electronics handling industry.

GENERAL INFORMATION	
Features	Antistatic, High Flow, Low ionics/Outgassing/Liquid particle count, No PFAS intentionally added
Fillers	Unreinforced
Polymer Types	Polycarbonate (PC)
Processing Techniques	Injection Molding

INDUSTRY	SUB INDUSTRY
Electrical and Electronics	Electronic Components
Industrial	Electrical, Material Handling

TYPICAL PROPERTY VALUES

Revision 20240716

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
MECHANICAL ⁽¹⁾			
Tensile Stress, brk, Type I, 50 mm/min	27.3	MPa	ASTM D638
Tensile Strain, brk, Type I, 50 mm/min	11.58	%	ASTM D638
Tensile Modulus, 50 mm/min	1986	MPa	ASTM D638
Flexural Strength, 1.3 mm/min, 50 mm span	72.8	MPa	ASTM D790
Flexural Modulus, 1.3 mm/min, 50 mm span	1790	MPa	ASTM D790
Tensile Stress, break, 50 mm/min	32	MPa	ISO 527
Tensile Strain, break, 50 mm/min	18.3	%	ISO 527
Tensile Modulus, 1 mm/min	2008	MPa	ISO 527
Flexural Strength, 2 mm/min	71.2	MPa	ISO 178
Flexural Modulus, 2 mm/min	1902	MPa	ISO 178
IMPACT ⁽¹⁾			
Izod Impact, notched, 23°C	671	J/m	ASTM D256
Izod Impact, unnotched, 23°C	NB	J/m	ASTM D4812
Izod Impact, notched 80*10*4 +23°C	47.8	kJ/m ²	ISO 180/1A
Izod Impact, unnotched 80*10*4 +23°C	NB	kJ/m ²	ISO 180/1U
Charpy 23°C, V-notch Edgew 80*10*4 sp=62mm	50.7	kJ/m ²	ISO 179/1eA
Charpy 23°C, Unnotch Edgew 80*10*4 sp=62mm	NB	kJ/m ²	ISO 179/1eU
THERMAL ⁽¹⁾			
HDT, 0.45 MPa, 3.2 mm, unannealed	105	°C	ASTM D648
HDT, 1.82 MPa, 3.2mm, unannealed	92	°C	ASTM D648
HDT/Bf, 0.45 MPa Flatw 80*10*4 sp=64mm	102	°C	ISO 75/Bf
HDT/Af, 1.8 MPa Flatw 80*10*4 sp=64mm	86.1	°C	ISO 75/Af

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
CTE, -40°C to 40°C, flow	7.6E-5	1/°C	ASTM E831
CTE, -40°C to 40°C, xflow	9.3E-5	1/°C	ASTM E831
CTE, -40°C to 40°C, flow	7.6E-5	1/°C	ISO 11359-2
CTE, -40°C to 40°C, xflow	9.8E-5	1/°C	ISO 11359-2
Vicat Softening Temp, Rate B/120	108	°C	ASTM D1525
Vicat Softening Temp, Rate B/120	109	°C	ISO 306
PHYSICAL ⁽¹⁾			
Specific Gravity	1.2	-	ASTM D792
Melt Flow Rate			
240°C/1.2 kgf	12	g/10 min	ASTM D1238
Water Absorption, (23°C/24hrs)	0.13	%	ASTM D570
Mold Shrinkage, flow ⁽²⁾	0.62	%	SABIC method
Mold Shrinkage, xflow ⁽²⁾	0.80	%	SABIC method
ELECTRICAL ⁽¹⁾			
Surface Resistivity	2.2E+9	Ω	ASTM D257
Volume Resistivity	5.2E+9	Ω.cm	ASTM D257
Dielectric Constant, 1.1 GHz	3.09	-	SABIC method
Dissipation Factor, 1.1 GHz	0.04092	-	SABIC method
Dielectric Constant, 1.9 GHz	3.01	-	SABIC method
Dissipation Factor, 1.9 GHz	0.04146	-	SABIC method
Dielectric Constant, 5 GHz	2.96	-	SABIC method
Dissipation Factor, 5 GHz	0.03409	-	SABIC method
Dielectric Constant, 10 GHz	2.99	-	SABIC method
Dissipation Factor, 10 GHz	0.02491	-	SABIC method
Dielectric Constant, 20 GHz	2.79	-	SABIC method
Dissipation Factor, 20 GHz	0.02646	-	SABIC method
INJECTION MOLDING ⁽³⁾			
Drying Temperature	75 – 80	°C	
Drying Time	6 – 8	Hrs	
Melt Temperature	240 – 250	°C	
Nozzle Temperature	240 – 250	°C	
Front - Zone 3 Temperature	240 – 250	°C	
Middle - Zone 2 Temperature	240 – 250	°C	
Rear - Zone 1 Temperature	240 – 250	°C	
Mold Temperature	40 – 60	°C	

(1) The information stated on Technical Datasheets should be used as indicative only for material selection purposes and not be utilized as specification or used for part or tool design.

(2) Measurements made from laboratory test coupon. Actual shrinkage may vary outside of range due to differences in processing conditions, equipment, part geometry and tool design. It is recommended that mold shrinkage studies be performed with surrogate or legacy tooling prior to cutting tools for new molded article.

(3) Injection Molding parameters are only mentioned as general guidelines. These may not apply or may need adjustment in specific situations such as low shot sizes, large part molding, thin wall molding and gas-assist molding.

ADDITIONAL PRODUCT NOTES

No PFAS intentionally added: The grade listed in this document does not contain PFAS intentionally added during Seller's manufacturing process and is not expected to contain unintentional PFAS impurities. Each user is responsible for evaluating the presence of unintentional PFAS impurities.



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